

2SK2383

Silicon N-Channel Power F-MOS FET

■ Features

- Avalanche energy capacity guaranteed
- High-speed switching
- Low ON-resistance
- No secondary breakdown

■ Applications

- Contactless relay
- Driving circuit for a solenoid
- Driving circuit for a motor
- Control equipment
- Switching power supply

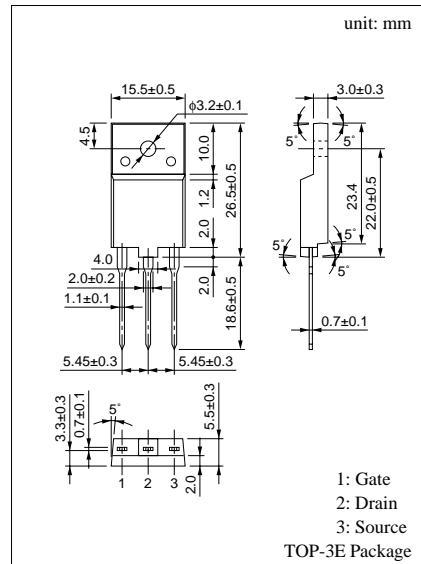
■ Absolute Maximum Ratings ($T_C = 25^\circ\text{C}$)

Parameter	Symbol	Ratings	Unit
Drain to Source breakdown voltage	V_{DSS}	500	V
Gate to Source voltage	V_{GSS}	± 30	V
Drain current	DC	I_D	A
	Pulse	I_{DP}	A
Avalanche energy capacity	EAS*	170	mJ
Allowable power dissipation	$T_C = 25^\circ\text{C}$	100	
		3	W
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

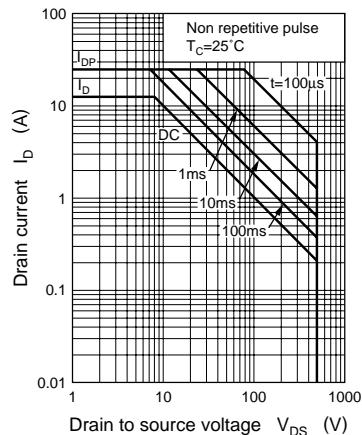
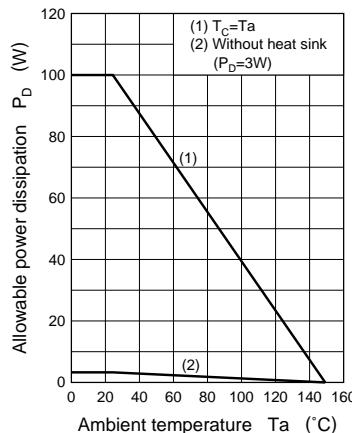
* $L = 2\text{mH}$, $I_L = 13\text{A}$, 1 pulse

■ Electrical Characteristics ($T_C = 25^\circ\text{C}$)

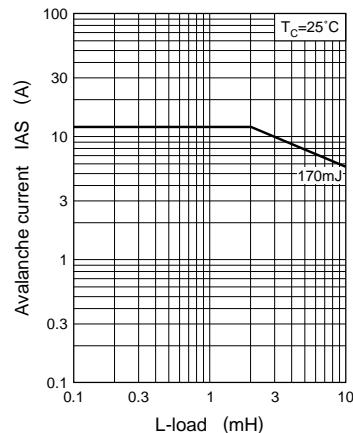
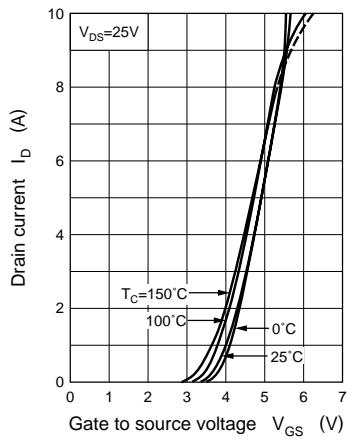
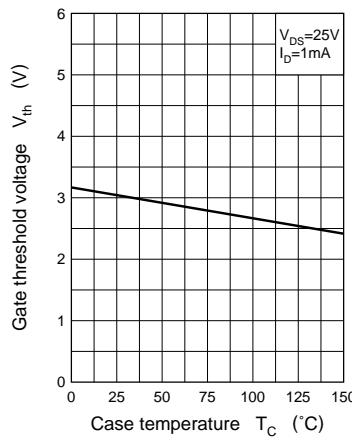
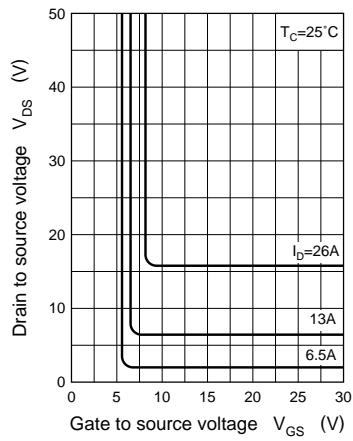
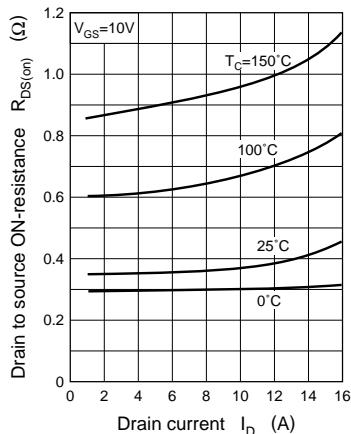
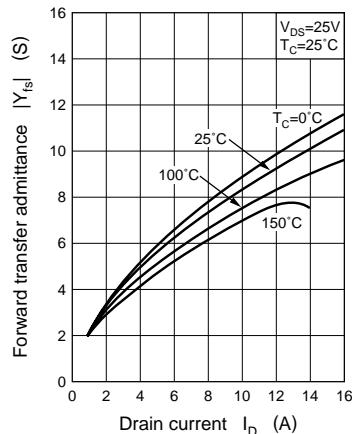
Parameter	Symbol	Conditions	min	typ	max	Unit
Drain to Source cut-off current	I_{DSS}	$V_{DS} = 400\text{V}$, $V_{GS} = 0$			100	μA
Gate to Source leakage current	I_{GSS}	$V_{GS} = \pm 30\text{V}$, $V_{DS} = 0$			± 1	μA
Drain to Source breakdown voltage	V_{DSS}	$I_D = 1\text{mA}$, $V_{GS} = 0$	500			V
Gate threshold voltage	V_{th}	$V_{DS} = 25\text{V}$, $I_D = 1\text{mA}$	1		5	V
Drain to Source ON-resistance	$R_{DS(on)}$	$V_{GS} = 10\text{V}$, $I_D = 7\text{A}$		0.45	0.6	Ω
Forward transfer admittance	$ Y_{fs} $	$V_{DS} = 25\text{V}$, $I_D = 7\text{A}$	5	8		S
Diode forward voltage	V_{DSF}	$I_{DR} = 13\text{A}$, $V_{GS} = 0$			-1.7	V
Input capacitance (Common Source)	C_{iss}	$V_{DS} = 20\text{V}$, $V_{GS} = 0$, $f = 1\text{MHz}$		1700		pF
Output capacitance (Common Source)	C_{oss}			300		pF
Reverse transfer capacitance (Common Source)	C_{rss}			120		pF
Turn-on time (delay time)	$t_{d(on)}$	$V_{DD} = 150\text{V}$, $I_D = 7\text{A}$ $V_{GS} = 10\text{V}$, $R_L = 21.4\Omega$		30		ns
Rise time	t_r			70		ns
Fall time	t_f			90		ns
Turn-off time (delay time)	$t_{d(off)}$			210		ns
Thermal resistance between channel and case	$R_{th(ch-c)}$				1.25	$^\circ\text{C}/\text{W}$
Thermal resistance between channel and atmosphere	$R_{th(ch-a)}$				41.67	$^\circ\text{C}/\text{W}$



Area of safe operation (ASO)

P_D — Ta

IAS — L-load

I_D — V_{GS}V_{th} — T_CV_{DS} — V_{GS}R_{DS(on)} — I_D|Y_{fs}| — I_DC_{iss}, C_{oss}, C_{tss} — V_{DS}